TOSHIBA CMOS DIGITAL INTEGRATED CIRCUIT SILICON MONOLITHIC

TC7S32F, TC7S32FU

2-INPUT OR GATE

The TC7S32 is a high speed C2MOS 2-INPUT OR GATE fabricated with silicon gate C2MOS technology. It achieves high speed operation similar to equivalent LSTTL while maintaining the C2MOS low power dissipation.

The internal circuit is composed of 2 stages including buffer output, which enables high noise immunity and stable output.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

Output currents are 1/2 compared to TC74HC series models.

FEATURES

•	High Speed	
		at $V_{CC} = 5V$

Low Power Dissipation I_{CC} = 1μ A (Max.)

at $Ta = 25^{\circ}C$

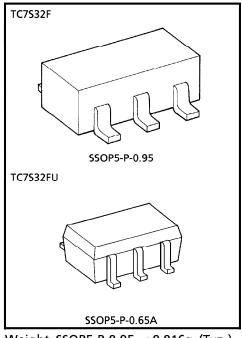
High Noise Immunity $V_{NIH} = V_{NIL}$ = 28% V_{CC} (Min.)

Output Drive Capability 5 LSTTL Loads

Symmetrical Output Impedance ... $|I_{OH}| = I_{OL}$ = 2mA (Min.)

Balanced Propagation Delays $t_{pLH} = t_{pHL}$

Wide Operating Voltage Range ... $V_{CC(opr)} = 2 \sim 6V$

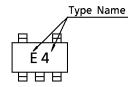


Weight SSOP5-P-0.95 : 0.016g (Typ.) SSOP5-P-0.65A: 0.006g (Typ.)

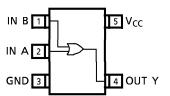
MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING	UNIT
Supply Voltage Range	Vcc	-0.5~7	V
DC Input Voltage	V _{IN}	-0.5~V _{CC} +0.5	V
DC Output Voltage	Vout	$-0.5 \sim V_{CC} + 0.5$	\
Input Diode Current	ΙΚ	± 20	mA
Output Diode Current	lok	± 20	mΑ
DC Output Current	lout	± 12.5	mΑ
DC V _{CC} /Ground Current	Icc	± 25	mΑ
Power Dissipation	PD	200	mW
Storage Temperature	T _{stg}	-65~150	°C
Lead Temperature (10s)	TL	260	°C

MARKING



PIN ASSIGNMENT (TOP VIEW)



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LOGIC DIAGRAM

$$\begin{array}{c|c} \text{IN B} & \underline{(1)} \\ \text{IN A} & \underline{(2)} \end{array} \hspace{0.2cm} \geqslant 1 \hspace{0.2cm} \underline{(4)} \hspace{0.2cm} \text{OUT Y}$$

RECOMMENDED OPERATING CONDITIONS

CHARACTERISTIC	SYMBOL	RATING	UNIT
Supply Voltage	Vcc	2~6	V
Input Voltage	VIN	0~V _{CC}	V
Output Voltage	Vout	0~V _{CC}	V
Operating Temperature	T _{opr}	- 40~85	°C
		$0\sim1000 \ (V_{CC}=2.0V)$	
Input Rise and Fall Time	t _r , t _f	$0 \sim 500 \ (V_{CC} = 4.5V)$	ns
		$0 \sim 400 \ (V_{CC} = 6.0V)$	

DC ELECTRICAL CHARACTERISTICS

CHARACTERISTIC	SYMBOL	TEST	ST CONDITION		Ta = 25°C			Ta = -40~85°C		UNIT
CHARACTERISTIC	3 TIVIBOL	TEST CONDITION		Vcc	MIN.	TYP.	MAX.	MIN.	MAX.	UNIT
Himb Laval				2.0	1.5	_	_	1.5	_	
High-Level	V _{IH}		_	4.5	3.15	_	—	3.15	<u> </u>	V
Input Voltage				6.0	4.2	_	—	4.2	—	
Lave Lavel				2.0	_	_	0.5	_	0.5	
Low-Level	VIL		_	4.5	l —	—	1.35	 	1.35	V
Input Voltage				6.0	—	—	1.8	_	1.8	
				2.0	1.9	2.0) — 1.9	_		
restate of	Voн	V _{IN} = V _{IH} or V _{IL}	$I_{OH} = -20\mu A$	4.5	4.4	4.5	—	4.4	_	_v
High-Level				6.0	5.9	6.0	—	5.9	 	
Output Voltage			I _{OH} = -2mA	4.5	4.18	4.31	_	4.13	_	
			$I_{OH} = -2.6mA$	6.0	5.68	5.80	 	5.63	—	
	V _{OL}	V _{IN} = V _{IL}	I _{OL} = 20μΑ	2.0	_	0.0	0.1	_	0.1	
l				4.5	l —	0.0	0.1	_	0.1	
Low-Level				6.0	—	0.0	0.1	_	0.1	V
Output Voltage			I _{OL} = 2mA	4.5	_	0.17	0.26	_	0.33	
			$I_{OL} = 2.6 mA$	6.0	—	0.18	0.26	_	0.33	
Input Leakage		V··· - V·· - Or CND		6.0			± 0.1		± 1.0	
Current	IN	$V_{IN} = V_{CC}$ or GND		0.0			_ 0.1		- 1.0	μΑ
Quiescent	laa	V.v. = V.c.s. (or CND	6.0			1.0		10.0	
Supply Current	lcc	$V_{IM} = V_{CC}$	JI GIND	0.0			1.0		10.0	μ A

Output currents are 1/2 compared to TC74HC series models.

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The information contained herein is subject to change without notice.

CHARACTERISTIC	SYMBOL TEST CONDITION	TEST CONDITION	Т	UNIT		
CHARACTERISTIC		MIN.	TYP.	MAX.	UINII	
Output Transition	tTLH			5	10	ns
Time	tTHL	_		,	10	113
Propagation Delay	t _{pLH}			7	15	nc
Time	t _{pHL}	_		_ ′ _	'3	ns

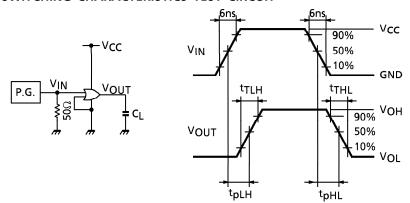
AC ELECTRICAL CHARACTERISTICS ($C_L = 50pF$, Input $t_r = t_f = 6ns$)

CHARACTERISTIC	SYMBOL	TEST CONDITION		Ta = 25°C			Ta = -4	UNIT	
CHARACTERISTIC	STIVIDOL		Vcc	MIN.	TYP.	MAX.	MIN.	MAX.	
Output Transition	tout Transition tour	ttlh tthl	2.0	_	50	125	_	155	
Time	l		4.5	<u> </u>	14	25	_	31	ns
Time	'IHL		6.0	_	12	21	—	26	
Propagation Dalay	_	_	2.0	_	48	100	_	125	
Propagation Delay	.		4.5	—	12	20	—	25	ns
Time	t _{pHL}		6.0	—	9	17	—	21	
Input Capacitance	CIN	_		_	5	10	_	10	
Power Dissipation Capacitance	C _{PD}	(Note 1)		_	10	_			pF

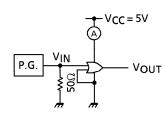
Note 1: CpD defined as the value of internal equivalent capacitance of IC which is calculated from the operating current consumption without load (refer to Test Circuit).

Average operating current can be obtained by the equation hereunder.

SWITCHING CHARACTERISTICS TEST CIRCUIT



ICC (opr) TEST CIRCUIT



Input waveform is the same as that in case of switching characteristics test.